

Vishay Siliconix

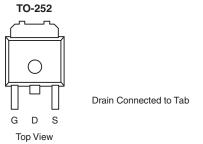
N-Channel 250-V (D-S) 175 °C MOSFET

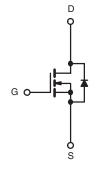
| PRODUCT SUMMARY | | | | |
|---------------------|---------------------------------|--------------------|--|--|
| V _{DS} (V) | $r_{DS(on)}\left(\Omega\right)$ | I _D (A) | | |
| 250 | 0.165 at V _{GS} = 10 V | 17 | | |

FEATURES

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature







N-Channel MOSFET

Ordering Information: SUD17N25-165-E3 (Lead (Pb)-free)

| ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted | | | | | | |
|--|-------------------------|-----------------------------------|------------------|----|--|--|
| Parameter | Symbol | Limit | Unit | | | |
| Drain-Source Voltage | V_{DS} | 250 | V | | | |
| Gate-Source Voltage | V _{GS} | ± 20 |] | | | |
| Continuous Drain Current (T _{.I} = 175 °C) ^b | T _C = 25 °C | I- | 17 | | | |
| Continuous Drain Current (1 _J = 1/5 °C) ² | T _C = 125 °C | l _D | 9.8 | | | |
| Pulsed Drain Current | I _{DM} | 20 | А | | | |
| Continuous Source Current (Diode Conduction) | I _S | 17 | | | | |
| Single Pulse Avalanche Current | I _{AS} | 5 |] | | | |
| Single Pulse Avalanche Energy | L = 0.1 mH | E _{AS} | 1.25 | mJ | | |
| Maximum Dayler Dissination | T _C = 25 °C | P _D | 136 ^b | W | | |
| Maximum Power Dissipation | T _A = 25 °C | T D | 3 ^a | | | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | - 55 to 175 | °C | | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------------|--------------|-------------------|---------|---------|------|--|
| Parameter | | Symbol | Typical | Maximum | Unit | |
| handing to Ambiguit | t ≤ 10 sec | R _{thJA} | 15 | 18 | °C/W | |
| Junction-to-Ambient ^a | Steady State | | 40 | 50 | | |
| Junction-to-Case (Drain) | | R _{thJC} | 0.85 | 1.1 | | |

- a. Surface Mounted on 1" x 1" FR4 Board.
- b. See SOA curve for voltage derating.

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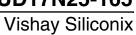


| SPECIFICATIONS $T_J = 25$ °C, unless otherwise noted | | | | | | | |
|---|---|---|-----|------------------|-------|------|--|
| Parameter | Symbol | Test Conditions | Min | Typ ^a | Max | Unit | |
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | $V_{(BR)DSS}$ $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | | 250 | | | V | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_{D} = 250 \mu A$ | 2.5 | | 4.0 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | | | ± 100 | nA | |
| | | $V_{DS} = 250 \text{ V}, V_{GS} = 0 \text{ V}$ | | | 1 | | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 250 V, V _{GS} = 0 V, T _J = 125 °C | | | 50 | μА | |
| | | V _{DS} = 250 V, V _{GS} = 0 V, T _J = 175 °C | | | 250 | | |
| On-State Drain Current ^b | I _{D(on)} | V _{DS} = 15 V, V _{GS} = 10 V | 17 | | | Α | |
| | | V _{GS} = 10 V, I _D = 14 A | | 0.131 | 0.165 | | |
| Drain-Source On-State Resistance ^b | r _{DS(on)} | V _{GS} = 10 V, I _D = 14 A, T _J = 125 °C | | | 0.347 | Ω | |
| | | V _{GS} = 10 V, I _D = 14 A, T _J = 175 °C | | | 0.462 | | |
| Forward Transconductance ^b | 9 _{fs} | V _{DS} = 15 V, I _D = 17 A | | 36 | | S | |
| Dynamic ^a | • | | | | | | |
| Input Capacitance | C _{iss} | | | 1950 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ | | 160 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 70 | | | |
| Total Gate Charge ^c | Q_g | | | 30 | 42 | | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 125 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 17 \text{ A}$ | | 10 | | nC | |
| Gate-Drain Charge ^c | Q_{gd} | | | 10 | | 1 | |
| Gate Resistance | R_g | | | 1.6 | | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 15 | 25 | | |
| Rise Time ^c | t _r | $V_{DD} = 125 \text{ V}, R_{L} = 7.35 \Omega$ | | 130 | 195 | | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 17 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$ | | 30 | 45 | ns | |
| Fall Time ^c | t _f | | | 100 | 150 | | |
| Source-Drain Diode Ratings and Characteristics (T _C = 25 °C) | | | | | | | |
| Pulsed Current | I _{SM} | | | | 20 | Α | |
| Diode Forward Voltage ^b | V_{SD} | I _F = 17 A, V _{GS} = 0 V | | 0.9 | 1.5 | V | |
| Source-Drain Reverse Recovery Time | t _{rr} | I _F = 17 A, di/dt = 100 A/μs | | 115 | 175 | ns | |

Notes:

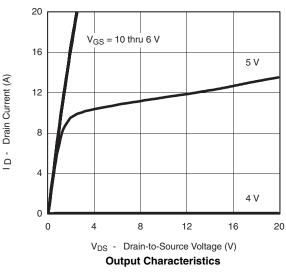
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

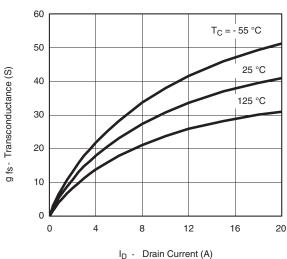
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

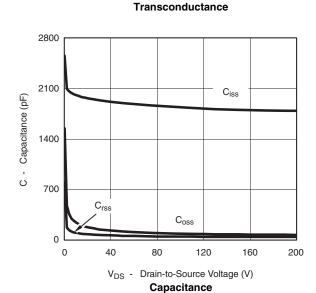


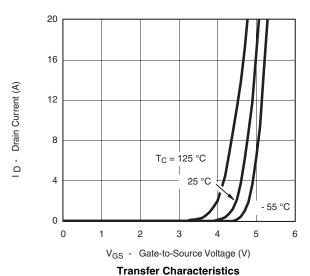


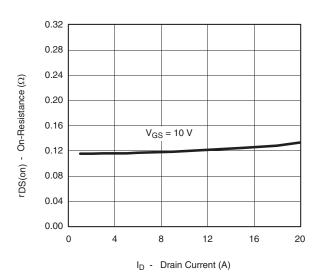
TYPICAL CHARACTERISTICS 25 °C unless noted

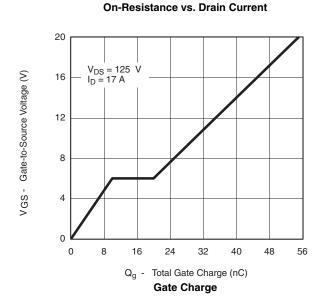












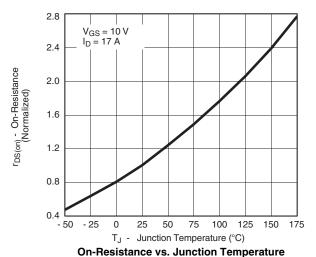
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TYPICAL CHARACTERISTICS 25 °C unless noted

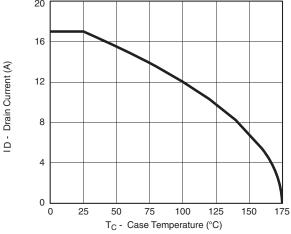


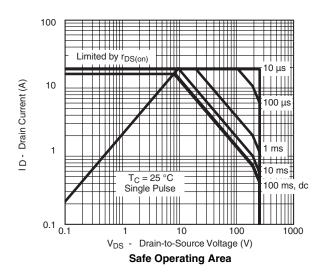


 $T_{J} = 150 \, ^{\circ}\text{C}$ $T_{J} = 150 \, ^{\circ}\text{C}$ $T_{J} = 25 \, ^{\circ}\text{C}$ $V_{SD} - \text{Source-to-Drain Voltage (V)}$ Source-Drain Diode Forward Voltage

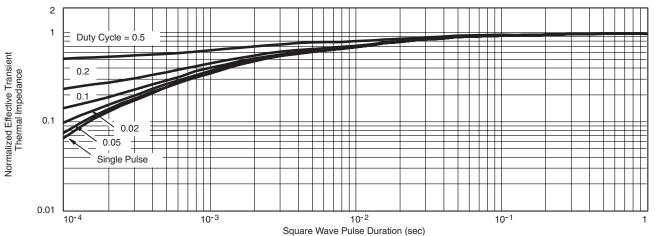
THERMAL RATINGS

I HERWAL RATINGS



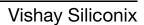


Maximum Avalanche Drain Current vs. Case Temperature



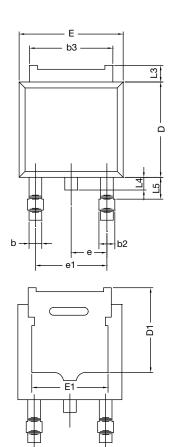
Normalized Thermal Transient Impedance, Junction-to-Case

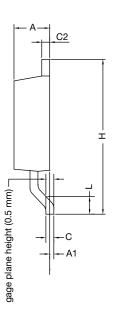
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72851.





TO-252AA Case Outline



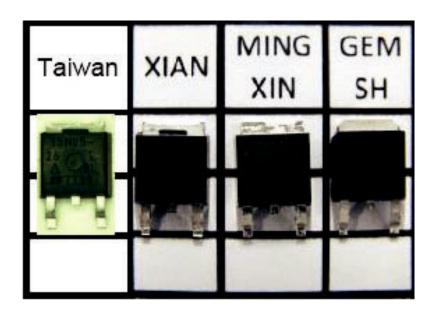


| | MILLIMETERS | | INC | HES | |
|---------------------------------|-------------|-------|-----------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| Α | 2.18 | 2.38 | 0.086 | 0.094 | |
| A1 | - | 0.127 | - | 0.005 | |
| b | 0.64 | 0.88 | 0.025 | 0.035 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| D1 | 4.10 | - | 0.161 | - | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | |
| E1 | 4.32 | - | 0.170 | - | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | |
| е | 2.28 | BSC | 0.090 BSC | | |
| e1 | 4.56 | BSC | 0.180 | BSC | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L4 | = | 1.02 | - | 0.040 | |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 | |
| ECN: T13-0359-Rev. O, 03-Jun-13 | | | | | |

DWG: 5347

Notes

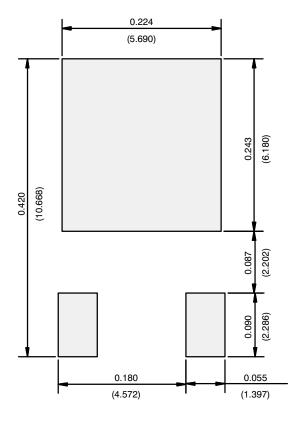
- Dimension L3 is for reference only.
- Xi'an, Mingxin, and GEM SH actual photo.



Revision: 03-Jun-13 Document Number: 71197



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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Revision: 02-Oct-12 Document Number: 91000